- **S1** Turn off power
- S2 Place monitor head on U3818DW curve sponge jig

Carefully slide and remove the I/O cover from the monitor



Disconnect the cables from the monitor and slide them out through the cablemanagement slot on the stand riser.



S4 Press and hold the stand release button



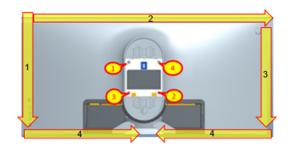
Lift the stand up and away from the monitor.



S6 Unlock 4 screws on rear cover

Use hands or scraper bar to disassemble Rear Cover from the monitor.

Notice the disassembly order: Left Side=> Top Side=> Right Side=> Bottom Side



(Screw Torque: 8-10 kgf)

Remove USB FFC and Audio FFC from USB BD

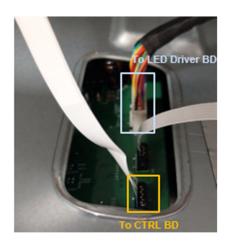




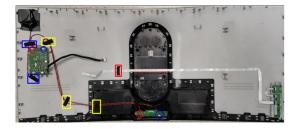
Remove 1 tape on LED Driver BD wire from Main SHD and disconnect LED Driver BD wire from I/F BD

Disconnect CTRL FFC cable from I/F BD and tear it from Main SHD

Take off Rear Cover

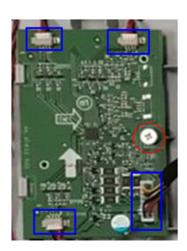


Remove all tapes from cables and Rear Cover



**S10** Remove all cables from LED Driver BD

Unlock 1 screw and disassemble LED Driver BD from Rear Cover

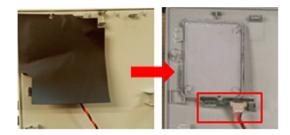


(Screw Torque: 4.5±0.5 kgf)

S11 Tear off "MYLAR HEAD LOGO" from cover LOGO LENS

Disconnect LED wire from LED BD

Disassemble LED BD from Rear Cover



S12 Tear off RC Mylar from USB BD and Jack BD



S13 Remove 2 tapes on Jack BD from Rear Cover

Disassemble Jack BD from Rear Cover

Remove 2 wires from Jack BD

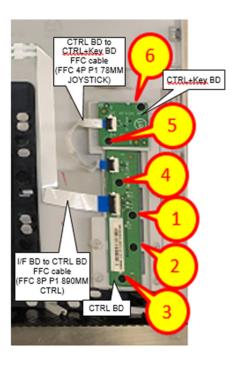
Unlock 2 screws to disassemble USB BD from Rear Cover



(Screw Torque: 4.5±0.5 kgf)

Remove FFC cable from Rear Cover, CTRL BD and CTRL+KEY BD

Unlock 6 screws to disassemble CTRL BD and CTRL+KEY BD from Rear Cover



(Screw Torque: 2.0±0.5 kgf)

S15 Take off 1 gasket from Middle Frame



S16 Disconnect Backlight Wires from SPS+LED BD

Tear off conductive cloth from Main SHD

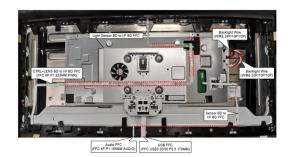




S17 Disconnect Light Sensor BD FFC cable from I/F BD and tear off it from Main SHD

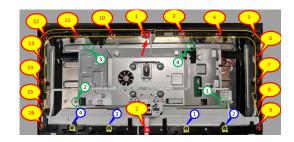
Disconnect Sensor BD FFC cable from I/F BD and tear off it from panel

Disconnect "CTRL+LENS BD FFC" from I/F BD and tear off it from panel and Main SHD



S18 Unlock 4 screws (Green mark) to disassemble Main SHD from panel

Unlock 16 screws (Red mark) and 4 screws (Yellow mark) to disassemble Middle Frame from Panel



(Screw Torque-Main SHD: 7±1kgf)

(Screw Torque-Middle Frame: 4.5±0.5 kgf)

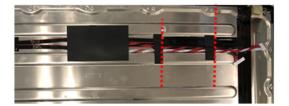
S19 Tear off a yellow tape and an acetate tape from EDP cable and panel

Disconnect EDP cable from Panel

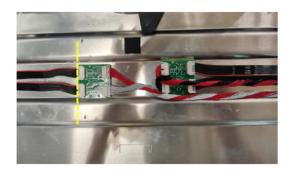
Take off Main SHD from Panel.



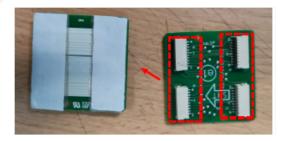
S20 Tear off a mylar and 2 tapes from Backlight wires



S21 Disconnect Backlight wires from transfer BD



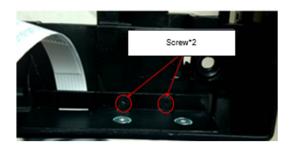
S22 Disassemble transfer BD from Panel



S23 Disassemble Light Sensor BD from Middle Frame

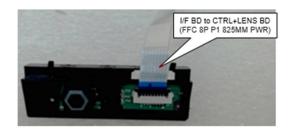


S24 Unlock 2 screws to disassemble Power Button module from Middle Frame



(Screw Torque: 1.1±0.1 kgf)

S25 Disconnect FFC cable from "CTRL+LENS BD" (Power CTRL BD)



Tear off "MYLAR-PWR-KE " from "CTRL+LENS BD" (Power CTRL BD)



S27 Unlock 2 screws to disassemble "CTRL+LENS BD" (Power CTRL BD) from Power Button



(Screw Torque: 2±0.5 kgf)

S28 Disassemble Sensor BD from Middle frame



S29 Unlock 1 screw to disassemble Docking BD from Main SHD

Disassemble wire from Docking BD



(Screw Torque: 8.5±1.0 kgf)

S30 Disassemble mylar from Main SHD



Tear off an adhesive tape and a yellow tape from I/F BD and EDP cable

Disconnect EDP cable from I/F BD



Unlock 11 screws on PCBA to disassemble SPS+LED BD, SPS BD and I/F BD from Main SHD

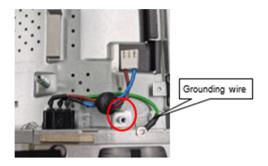


(Screw Torque: 8.5±1.0 kgf)

S33 Disconnect wires from I/F BD, SPS BD and SPS+LED BD

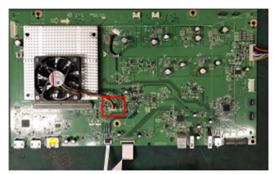


S34 Unlock 1 ground screw to disassemble AC Socket from Main SHD



(Screw Torque: 8-10 kgf)

S35 Disconnect Fan Cable from I/F BD



S36 Unlock 4 screws to disassemble G-SYNC Module from I/F BD



(Screw Torque: 4-4.5 kgf)

S37 Unlock 4 Heat Sink screws and 4 captive screws to disassemble G-Sync module, Heat Sink Module and SHEET STIFFENER

Tear off MYLAR from SHEET STIFFENER



(Screw Torque-Heat Sink: 2-2.5 kgf)



SHEET STIFFENER assembled with mylar

(Screw Torque-Captive screw:4-4.5 kgf)

**S38** 

Remove electrolyte capacitors (red mark) from printed circuit boards

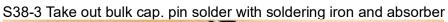


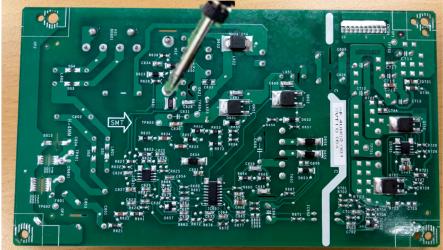
S38-1 Cut the glue between bulk cap. and PCB with a knife



S38-2 Ensure cutting path within the glue, don't touch bulk cap. or PCB







S38-4 Lift the bulk cap. up and away from the PCB



## 2. Product material information

The following substances, preparations, or components should be disposed of or recovered separately from other WEEE in compliance with Article 4 of EU Council Directive 75/442/EEC.

| Capacitors / condensers (containing PCB/PCT)   | No used                                |
|--|--|
| Mercury containing components                  | No used                                |
| Batteries                                      | No used                                |
| Printed circuit boards (with a surface greater | Product has printed circuit boards     |
| than 10 square cm)                             | (with a surface greater than 10 square |
|  | cm)                                    |
| Component contain toner, ink and liquids       | No used                                |
| Plastic containing BFR                         | No used                                |
| Component and waste contain asbestos           | No used                                |
| CRT  | No used                                |
| Component contain CFC, HCFC, HFC and           | No used                                |
| HC   |  |
| Gas discharge lamps                            | No used                                |
| LCD display > 100 cm2                          | Product has an LCD greater than 100    |
|  | cm2                                    |
| External electric cable                        | Product has external cables            |
| Component contain refractory ceramic fibers    | No used                                |
| Component contain radio-active substances      | No used                                |
| Electrolyte capacitors (height                 | Product has electrolyte capacitors     |
| > 25mm, diameter > 25mm)                       | (height >25mm, diameter > 25mm)        |

## 3. Tools Required

List the type and size of the tools that would typically can be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

Tool Description:

- Screwdriver
- Scraper Bar
- Penknife
- Soldering iron and absorber
- Curve Sponge Jig